



Receipt
Patent

Case No.: 53415US038

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: **HARDY, L. CHARLES**

Application No.: **09/707,269**

Group Art Unit: **2825**

Filed: **November 6, 2000**

Examiner: **Caridad Everhart**

Title: **METHOD OF MODIFYING A WAFER SUITED FOR SEMICONDUCTOR
FABRICATION**

REQUEST FOR CORRECTED FILING RECEIPT

Office of Initial Patent Examination's
Customer Service Center
Commissioner for Patents
Washington, DC 20231

Dear Sir:

The Filing Receipt for the above-identified application contains one or more photocopy of the Filing Receipt with the correction(s) noted thereon is enclosed.

Please correct the Filing Receipt to include all the priority data as stated below:

THIS APPLICATION IS A CONTINUATION OF 09/091,932, FILED JUNE 24, 1998; WHICH IS A 371 OF PCT/US/98/08693, FILED APRIL 30, 1998, WHICH IS A CONTINUATION-IN-PART OF 08/846,726, FILED APRIL 30, 1997

Correction of the records at the United States Patent and Trademark Office and issuance of a corrected Filing Receipt are respectfully requested

Respectfully submitted,

November 1, 2002
Date

By:

Colene H. Blank
Colene H. Blank, Reg. No.: 41,056
Telephone No.: 651-737-2356

Office of Intellectual Property Counsel
3M Innovative Properties Company
P.O. Box 33427
St. Paul, MN 55133-3427

CHB/spg
53415US038 CORRECT FILING RECEIPT

RECEIVED
NOV 20 2002
TECHNOLOGY CENTER 2800



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
www.uspto.gov

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/707,269	11/06/2000	2825	710	INTEL 53415 USA8C.038		20	1

OFFICE OF INTELLECTUAL PROPERTY COUNSEL
3M INNOVATIVE PROPERTIES COMPANY

CONFIRMATION NO. 9169

Office of Intellectual Property Counsel
3M Innovative Properties Company
P.O. Box 33427
St. Paul, MN 55133-3427

JAN 15 2001

FILING RECEIPT



OC000000005656774

REFERRED TO

CHB

me

Date Mailed: 01/05/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

David K. Kaisaki, St. Paul, MN;
Heather K. Kranz, St. Paul, MN;
Thomas E. Wood, St. Paul, MN;
L. Charles Hardy, St. Paul, MN;

Continuing Data as Claimed by Applicant

THIS APPLICATION IS A CON OF 09/091,932 06/24/1998
WHICH IS A 371 OF PCT/US98/08693 04/30/1998

WHICH IS A CONTINUATION-IN-PART OF 08/846,726, FILED 04/30/1997

Foreign Applications

If Required, Foreign Filing License Granted 01/05/2001

Projected Publication Date:

Non-Publication Request: No

Early Publication Request: No

Title

Method of modifying a wafer suited for semiconductor fabrication

RECEIVED
NOV 20 2002
TECHNOLOGY CENTER 2800



UNITED STATES
PATENT AND
TRADEMARK OFFICE

FILE COPY

Commissioner for Patents
Washington, DC 20231
www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 9169

SERIAL NUMBER 09/707,269	FILING DATE 11/06/2000 RULE	CLASS 438	GROUP ART UNIT 2825	ATTORNEY DOCKET NO. 53415USA8C.038
APPLICANTS David K. Kaisaki, St. Paul, MN; Heather K. Kranz, St. Paul, MN; Thomas E. Wood, St. Paul, MN; L. Charles Hardy, St. Paul, MN;				
** CONTINUING DATA ***** This application is a CON of 09/091,932 06/24/1998 PAT 6,194,317 which is a 371 of PCT/US98/08693 04/30/1998 which is a CIP of 08/846,726 04/30/1997 ABN				
** FOREIGN APPLICATIONS *****				
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 01/05/2001				
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and Acknowledged _____ Examiner's Signature Initials		STATE OR COUNTRY MN	SHEETS DRAWING	TOTAL CLAIMS 20
				INDEPENDENT CLAIMS 1
ADDRESS Office of Intellectual Property Counsel 3M Innovative Properties Company P.O. Box 33427 St. Paul, MN 55133-3427				
TITLE Method of modifying a wafer suited for semiconductor fabrication				
FILING FEE RECEIVED 710	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	

RECEIVED
NOV 20 2002
TECHNOLOGY CENTER 2800